

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MICHIO HORIUCHI	04/03/2014
RYO FUKASAWA	04/03/2014
YUICHI MATSUDA	04/03/2014
YASUE TOKUTAKE	04/03/2014
RECEIVING PARTY DATA	
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City:	NAGANO-SHI, NAGANO
State/Country:	JAPAN
Postal Code:	381-2287
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14260588
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ATTORNEY DOCKET NUMBER:	140105
NAME OF SUBMITTER:	MEL R. QUINTOS
SIGNATURE:	/MRQ/
DATE SIGNED:	05/09/2014
Total Attachments: 1	
source=140105 Assignment#page1.tif	

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by
Shinko Electric Industries Co., Ltd.,

(Insert ASSIGNEE's
Name(s) Address(es))

80, Oshimada-machi, Nagano-shi, Nagano 381-2287 Japan

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled:

(Title of Invention)

**ELECTRONIC COMPONENT DEVICE AND METHOD OF MANUFACTURING THE
SAME**

(*If the assignment is
being filed after the
filing of the
application, this
section must be
completed)

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

April 24, 2014

* filed on _____, Serial No. 14/260,588

(Kratz, Quintos & Hanson, LLP is hereby authorized to insert the serial code, serial number and/or filing date hereon, when known)

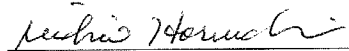
and all Letters Patent of the United States to be obtained therefor on said application or any continuation, divisional, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with the application and any continuation, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, divisional, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Signatures)


(Signature)

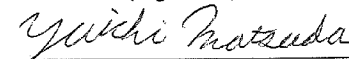
Michio HORIUCHI
(Type Name)

April 3, 2014
(Date)


(Signature)

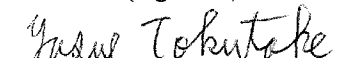
Ryo FUKASAWA
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April 3, 2014
(Date)


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April 3, 2014
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Yasue TOKUTAKE
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NO LEGALIZATION REQUIRED

Re. 07/07